150KHz, 3A PWM Buck DC/DC Converter

GENERAL DESCRIPTION

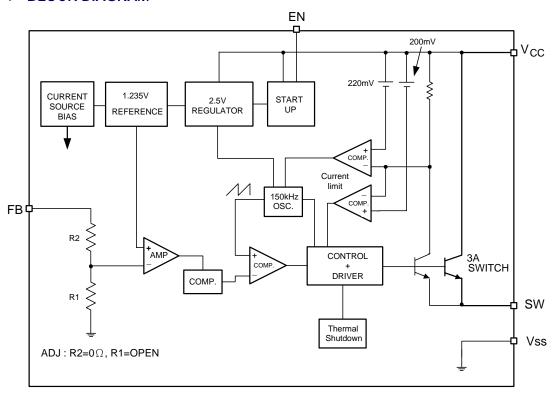
The AX3006 series are monolithic IC designed for a step-down DC/DC converter, and own the ability of driving a 3A load without additional transistor. It saves board space. The external shutdown function can be controlled by logic level and then come into standby mode. The internal compensation makes feedback control having good line and load regulation without external design. Regarding protected function, thermal shutdown is to prevent over temperature operating from damage, and current limit is against over current operating of the output switch. If current limit function occurs and V_{FB} is down below 0.5V, the switching frequency will be reduced. The AX3006 series operates at a switching frequency of 150KHz thus allow smaller sized filter components than what would be needed with lower frequency switching regulators. The output version included fixed 3.3V, 5V, 12V, and an adjustable type. The chips are available in a 5-lead TO-252 package.

FEATURES

- Output voltage: 3.3V, 5V, 12V and adjustable output version.
- Adjustable version output voltage range, 1.23V to 38.5V.
- 150KHz fixed switching frequency.
- Voltage mode non-synchronous PWM control.
- Thermal-shutdown and current-limit protection.
- ON/OFF shutdown control input.
- Short Circuit Protect (SCP).
- Operating voltage can be up to 40V.
- Output load current: 3A.
- 5-Lead TO-252 Pb-Free packages.
- Low power standby mode.
- Built-in switching transistor on chip.

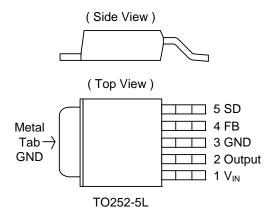


BLOCK DIAGRAM



❖ PIN ASSIGNMENT

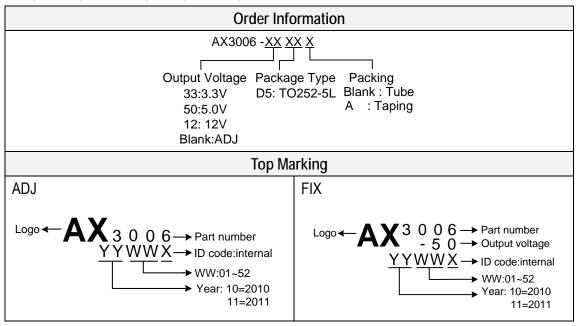
The package of AX3006 is TO252-5L; the pin assignment is given by:



Name	Description			
V_{CC}	Operating voltage input			
SW	Switching output			
V_{SS}	GND pin			
FB	Output voltage feedback control			
EN	ON/OFF Shutdown			



❖ ORDER/MARKING INFORMATION



❖ ABSOLUTE MAXIMUM RATINGS

Characteristics	Symbol	Rating	Unit
Maximum Supply Voltage	V _{CC}	+45	V
ON/OFF Pin Input Voltage	V_{EN}	-0.3 to 40	V
Feedback Pin Voltage	V_{FB}	-0.3 to 12	V
Output Voltage to Ground	V _{OUT}	-0.8~45	V
Power Dissipation Internally limited	PD	(T _J -T _A) / θ _{JA}	W
Storage Temperature Range	T _{ST}	-65 to +150	°C
Operating Junction Temperature Range	TJ	-20 to +125	°C
Operating Supply Voltage	V _{OP}	+4.5 to +40	V
Thermal Resistance from Junction to case	θ _{JC}	8	°C/W
Thermal Resistance from Junction to ambient	θ_{JA}	50	°C/W

Note: θ_{JA} is measured with the PCB copper area(need connect to V_{SS} pins) of approximately 3 in² (Multi-layer).

❖ ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, T_A=25°C, V_{CC}=12V for 3.3V, 5V, adjustable version and V_{CC} =18V for the 12V version. I_{LOAD} = 0.2A)

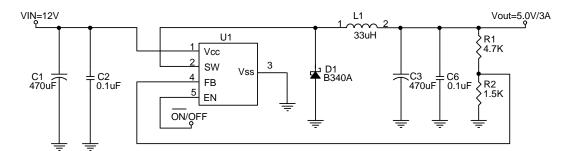
Characteristics		Symbol	Conditions		Тур	Max	Units
Quiescent Current		IQ	V _{FB} =12V force driver off	-	4	8	mA
Feedback bias	s current	I _{FB}	V _{FB} =1.3V (Adjustable version only)		-10	-50	nA
Shutdown sup	ply Current	I _{SD}	EN pin=5V, V _{CC} =40V		100	200	uA
Oscillator freq	uency	Fosc		127	150	173	KHz
Oscillator frequency of short circuit		F _{SCP}	(Adjustable) When V _{FB} <0.5V		50	-	KHz
protect			(Fixed)When <v<sub>OUT*40%</v<sub>	-	50	-	KHz
Max. Duty Cyc	cle (ON)	DC	V _{FB} =0V force driver on	-	100	-	%
Min. Duty Cyc	le (OFF)		V _{FB} =12V force driver off	-	0	-	/0
Current limit		I _{CL}	Pear current, No outside circuit V FB=0V force driver on	3.3	ı	-	Α
Load Regulati	on($\triangle V_{OUT}/V_{OUT}$)	$\triangle V_{\text{OUT}}$	$I_{OUT} = 0.2 \text{ to } 3A$	-	0.6	1.2	%
Saturation voltage		V _{SAT}	I _{OUT} =3A, No outside circuit V _{FB} =0V force driver on	-	1.3	1.5	V
SW pin=0V	SW pin leakage	I _{SW L}	No outside circuit V _{FB} =12V force driver off	-	ı	-200	uA
SW pin=-1V	current	IOW L	V _{CC} =40V force driver off	-	-5		mΑ
EN pin logic input threshold voltage		V _{IL}	Low (regulator ON)		1.3	0.6	V
		V _{IH}	High (regulator OFF)	2.0	1.0	-	V
EN pin logic input current		lΗ	V _{EN} =2.5V (OFF)	-	-0.1	-10	uA
EN pin input current		ΙL	V _{EN} =0.5V (ON)	-	-0.01	-1	uA
Thermal shutdown Temp		T _{SD}		-	135	-	°C

❖ ELECTRICAL CHARACTERISTICS (CONTINUED)

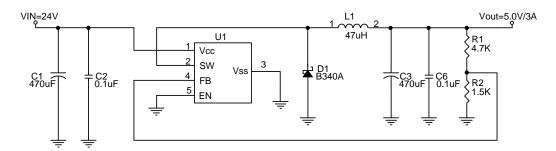
Version	Characteristics	Symbol	Conditions	Min	Тур	Max	Units
			I _{LOAD} =0.2A				
AX3006-ADJ	Output Feedback voltage	V_{FB}	V _{OUT} programmed	1.193	1.23	1.267	V
ANJUUU-ADJ			for 3.3V				
	Efficiency	η	$V_{CC} = 12V$, $I_{LOAD} = 3A$	-	74	-	%
IAX3006-3.3V	Output voltage	V _{OUT}	I _{LOAD} =0.2A	3.20	3.30	3.40	V
	Efficiency	η	V_{CC} = 12V, I_{LOAD} =3A	-	75	-	%
IAX3006-5 0V	Output voltage	V _{OUT}	I _{LOAD} =0.2A	4.85	5.00	5.15	V
	Efficiency	η	$V_{CC} = 12V$, $I_{LOAD} = 3A$	-	80	-	%
I AX3006-12V	Output voltage	V _{OUT}	I _{LOAD} =0.2A	11.64	12.0	12.36	V
	Efficiency	η	$V_{CC} = 15V, I_{LOAD} = 3A$	-	89	-	%

❖ APPLICATION CIRCUIT

(1) $V_{IN}=12V$



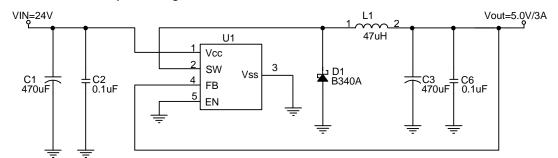
(2) $V_{IN}=24V$



$$V_{OUT} = V_{FB} \times (1 + \frac{R1}{R2}), V_{FB} = 1.23V, R2 = 0.7K \sim 3K$$

V _{OUT}	R2	R1
5.0V	1.5K	4.7K
3.3V	1.5K	2.5K
2.5V	1.5K	1.5K

(3) Fixed Output Voltage Version



L1 recommend value (I _{OUT} =3A,)							
V _{OUT} 2.5V 3.3V 5V 12V							
V _{IN} =12V	V _{IN} =12V 33uH		33~47uH	NA			
V _{IN} =24V	33uH	33uH	47uH	68uH			

FUNCTION DESCRIPTIONS

Pin Functions

 ν_{cc}

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be presented at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

Vss

Circuit ground.

SW

Internal switch. The voltage at this pin switches between (+V_{CC} - V_{SAT}) and approximately -0.5V, with a duty cycle of approximately V_{OUT} / V_{CC}. To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be minimized.

Feedback

Senses the regulated output voltage to complete the feedback loop.

EN

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 100uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of V_{CC}) shuts the regulator down. If this shutdown feature is not needed, the EN pin can be wired to the ground pin.

Thermal Considerations

The TO252-5L package needs a heat sink under most conditions. The size of the heat sink depends on the input voltage, the output voltage, the load current and the ambient temperature. The AX3006 junction temperature rises above ambient temperature for a 3A load and different input and output voltages.

The data for these curves was taken with the AX3006 (TO252-5L package) operating as a buck-switching regulator in an ambient temperature of 25°C (still air). These temperature increments are all approximate and are affected by many factors. Higher ambient temperatures require more heat sinker.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper (need connect to the V_{SS} pins) should be used in the board layout, (One exception is the SW(switch) pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

Package thermal resistance and junction temperature increments are all approximate. The increments are affected by a lot of factors. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness, single or double-sided, multi-layer board and the amount of solder on the board.

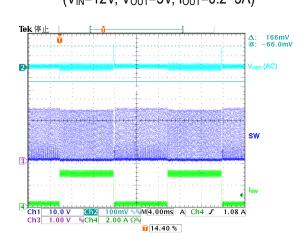
The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



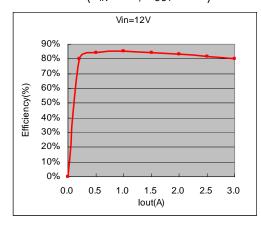
TYPICAL CHARACTERISTICS

Output Ripple $(V_{IN}=12V, V_{OUT}=5V, I_{OUT}=3A)$ out (AC) Ch1 頻率 156.6kHz Ch1 5.00 V % M2.00μs A Ω M2.0

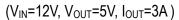
Load Transient Response (V_{IN}=12V, V_{OUT}=5V, I_{OUT}=0.2~3A)

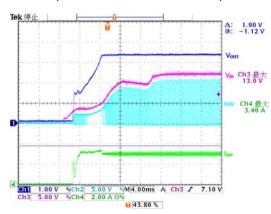


Efficiency $(V_{IN}=12V, V_{OUT}=5.0V)$



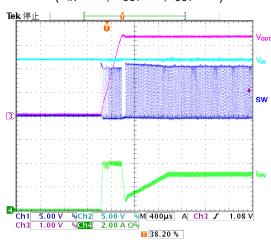
Power on test wave





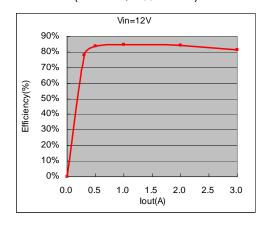
EN on test wave

 $(V_{IN}=12V, V_{OUT}=5V, I_{OUT}=3A)$



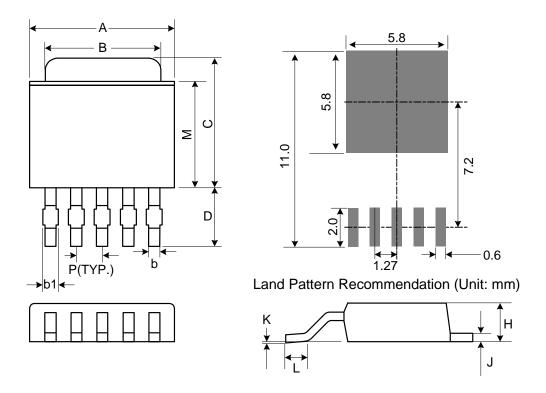
Efficiency

 $(V_{IN}=24V, V_{OUT}=5.0V)$





❖ PACKAGE OUTLINES



Symbol	Dimensions in Millimeters			Dimensions in Inches			
	Min.	Nom.	Max.	Min.	Nom.	Max.	
А	6.35	6.6	6.73	0.250	0.260	0.265	
В	5.21	5.33	5.46	0.205	0.210	0.215	
С	6.86	7.24	7.62	0.270	0.285	0.300	
D		2.67 REF		0.105 REF			
Р	1.27 REF			0.050 REF			
Н	2.18	2.29	2.39	0.086	0.090	0.094	
J	0.46	0.51	0.58	0.018	0.020	0.023	
K	0.00	0.08	0.13	0.000	0.003	0.005	
L	1.40	1.60	1.78	0.055	0.063	0.070	
М	5.33	5.46	5.59	0.210	0.215	0.220	
b	0.38	0.56	0.71	0.015	0.022	0.028	
b1	0.38	0.53	0.66	0.015	0.021	0.026	

Mold flash shall not exceed 0.005inch per side